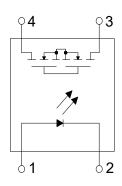
## KAQY212 Series 4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

#### Description

The KAQY212 series is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

#### Schematic



1 FORM A NORMALLY OPEN





#### Features

- 1. Normally open, single pole single throw
- 2. Control 60V AC or DC voltage
- 3. Switch 400mA loads
- 4. Controls low-level analog signals
- 5. High sensitivity, low ON resistance
- 6. Low-level off-state leakage current
- 7. High isolation voltage 5KV (DIP / SMD)
- 8. Pb free and RoHS compliant
- 9. MSL class 1
- 10. Agency Approvals:
  - UL Approved (No. E108430): UL508
  - c-UL Approved (No. E108430)
  - FIMKO Approved: EN62368-1, EN60601-1
  - VDE Approved (No. 40053989): EN60747-5-5

#### Application

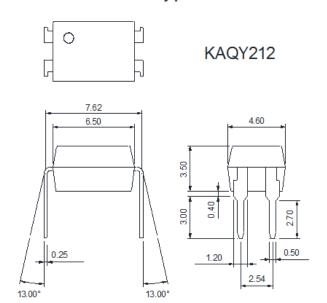
- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- High speed inspection machines

## 4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

#### Outside Dimension

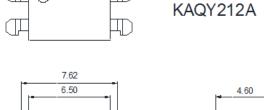
Unit: mm

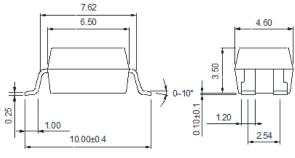
1. Dual-in-line type.



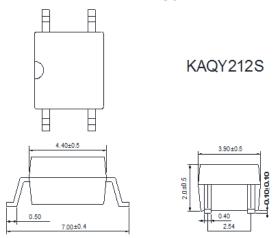
2. Surface mount type.

OHD



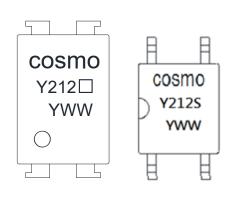


Small outline for surface mount type.



TOLERANCE: ±0.2mm

#### Device Marking



Notes:

cosmo

Y212 ☐ (Blank) : DIP or SMD

Y212S S: SOP

YWW Y: Year code / W: Week code

### **KAQY212 Series**

## 4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

#### Absolute Maximum Ratings

(Ta=25°ℂ)

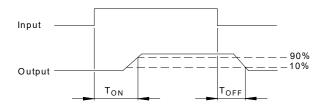
Item		Symbol	Rating	Unit
Input	Continuous forward current	I <sub>F</sub>	50	mA
	Peak forward current	I <sub>FP</sub>	1	А
	Reverse voltage	$V_R$	5	V
	Power dissipation	P <sub>in</sub>	100	mW
	Derate linearly from 25°C	-	1.3	mW/℃
	Breakdown voltage	V <sub>B</sub>	60	V
Output	Continuous load current	ΙL	400	mA
	Power dissipation	P <sub>out</sub>	500	mW
Isolation voltage		V	KAQY212S	KAQY212
		V <sub>iso</sub>	1500Vrms	5000Vrms
Isolation resistance (Vio=500V)		R <sub>iso</sub>	≥10 <sup>10</sup>	Ω
Total power dissipation		Pt	550	mW
Derate linearly from 25°ℂ		-	2.5	mW/°C
Operating temperature		T <sub>opr</sub>	-40 to +85	$^{\circ}\! \mathbb{C}$
Storage temperature		T <sub>stg</sub>	-40 to +125	$^{\circ}\!\mathbb{C}$
Junction temperature		T <sub>j</sub>	100	$^{\circ}\!\mathbb{C}$
Soldering temperature 10 seconds		T <sub>sot</sub>	260	$^{\circ}\!\mathbb{C}$

#### • Electro-optical Characteristics

(Ta=25°ℂ)

	Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =10mA	-	1.2	1.5	V
Input	Operation input current	I <sub>FON</sub>	V <sub>L</sub> =20V, I <sub>L</sub> =100mA	-	-	3.0	mA
	Recovery input current	I <sub>FOFF</sub>	V <sub>L</sub> =20V, I <sub>L</sub> ≦5μA	0.2	-	-	mA
Output	Breakdown voltage	V <sub>B</sub>	I <sub>B</sub> =50μA	60	-	-	V
	Off-state leakage current	I <sub>LEAK</sub>	V <sub>L</sub> =60V, I <sub>F</sub> =0mA	-	0.2	1.0	μΑ
I/O capacitance		C <sub>iso</sub>	V <sub>B</sub> =0V, f=1MHz	-	6	-	pF
ON resistance		R <sub>ON</sub>	I <sub>F</sub> =10mA, I <sub>L</sub> =100mA	-	0.83	2.5	Ω
Turn-on time		T <sub>ON</sub>	I <sub>F</sub> =10mA, V <sub>L</sub> =20V	-	0.3	1.5	ms
Turn-off time		T <sub>OFF</sub>	I <sub>L</sub> =100mA, t=10ms - 0.1		0.1	1.5	ms

#### Turn-on / Turn-off Time

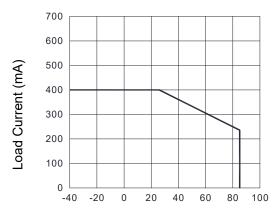


#### • Schematic and Wiring Diagrams

Schematic	Output Configuration	Load	Connection	Wiring Diagrams
	1a	AC DC	-	V <sub>N</sub> I <sub>F</sub> 1 V <sub>L</sub> (AC,DC)

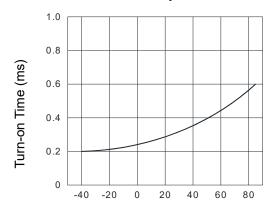
#### **4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT**

**Load Current** Fig.1 vs. Ambient Temperature



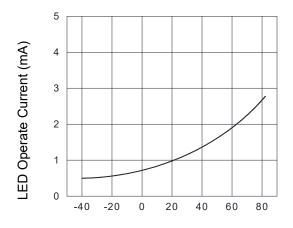
Ambient Temperature Ta (°C)

Fig.3 **Turn-on Time** vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.5 LED Operate Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

On Resistance Fig.2 vs. Ambient Temperature

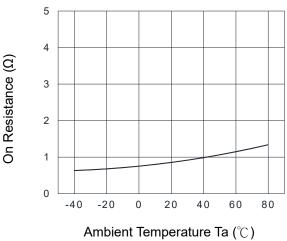
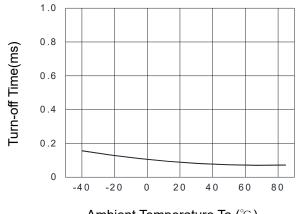
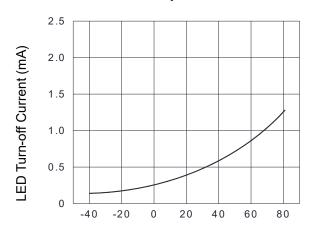


Fig.4 **Turn-off Time** vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.6 **LED Turn-off Current** vs. Ambient Temperature



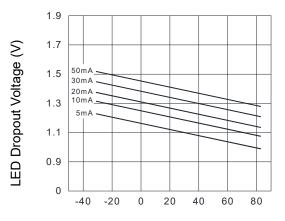
Ambient Temperature Ta (°C)



#### **KAQY212 Series**

4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

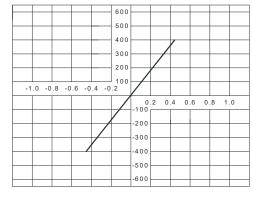
## Fig.7 LED Dropout Voltage vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion





Voltage (V)

Fig.9 Turn-on Time vs. LED Forward Current

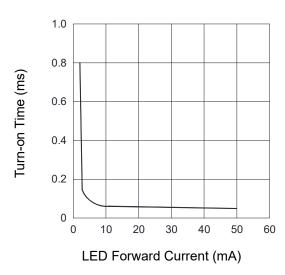
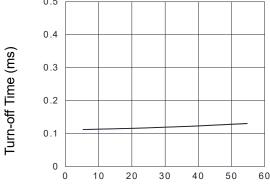


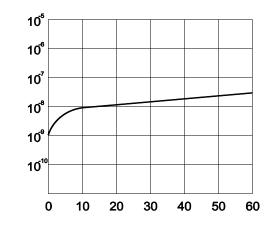
Fig.11 Turn-off Time vs. LED Forward Current



LED Forward Current (mA)

Fig.10 Off-state Leakage Current vs. Load Voltage



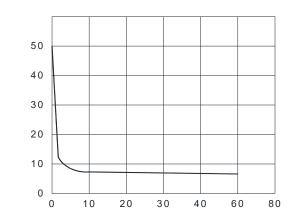


Load Voltage (V)

Fig.12 Output Capacitance vs. Applied Voltage



Output Capacitance (pF)



Applied Voltage (V)

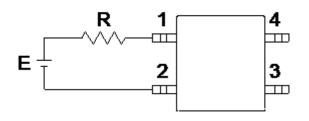
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- 6 -



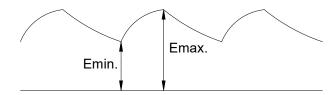
#### Using Methods

Examples of resistance value to control LED forward current (I<sub>F</sub>=5mA)

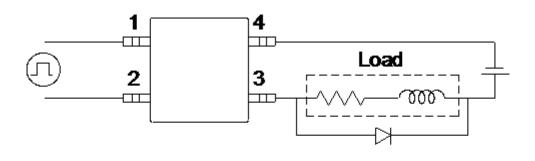


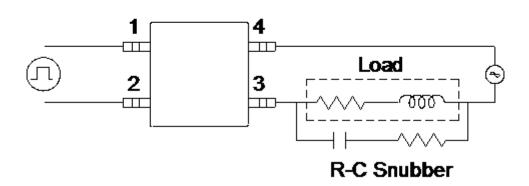
Е	R
3.3V	Approx. 330 Ω
5V	Approx. 640 Ω
12V	Approx. 1.9K Ω
15V	Approx. 2.5K Ω
24V	Approx. 4.1K Ω

- 1. LED forward current must be more than 5mA, at E min.
- 2. LED forward current must be less than 50mA, at E max.



Regulate the spike voltage generated on the inductive load as follows:





#### Recommended Soldering Conditions

#### (a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature: 10 sec
 ■ Time of temperature higher than 230°C: 30-60 sec
 ■ Time to preheat temperature from 60-120 sec

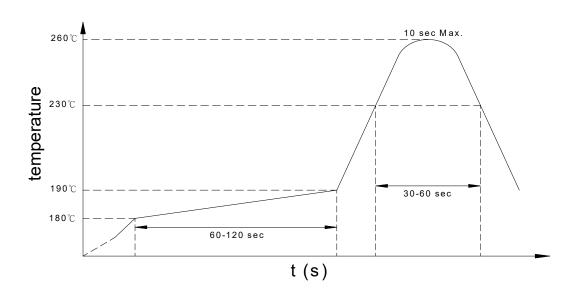
180~190°C : Two

■ Number of reflows : Rosin flux containing small amount of chlorine

■ Flux: (The flux with a maximum chlorine content of 0.2

Wt% is recommended.)

#### **Recommended Temperature Profile of Infrared Reflow**



#### (b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time : 10 seconds or less

■ Preheating conditions: 120°C or below (package surface temperature)

■ Number of times : One

■ Flux: Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

Fluxes: Avoid removing the residual flux with freon-based and

chlorine-based cleaning solvent.

Avoid shorting between portion of frame and leads.



#### Numbering System

#### **KAQY212** X (Y)

#### Note:

KAQY212 = Part No.

 $X = Lead form option (blank \cdot S or A)$ 

Y = Tape and reel option (TLD · TRU)

Option	Description	Packing quantity	
A (TLD)	surface mount type package + TLD tape & reel option	2000 units per reel	
A (TRU)	surface mount type package + TRU tape & reel option	2000 units per reel	
S (TLD)	small outline for surface mount type package +	3000 units per reel	
0 (122)	TLD tape & reel option	occo anno per reer	
e /TDU\	small outline for surface mount type package +	2000 units per real	
S (TRU)	TRU tape & reel option	3000 units per reel	

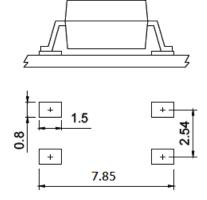
#### • Recommended Pad Layout for Surface Mount Lead Form

#### 1. Surface mount type.

# 4-pin SMD

#### 2. Small outline for surface mount type.

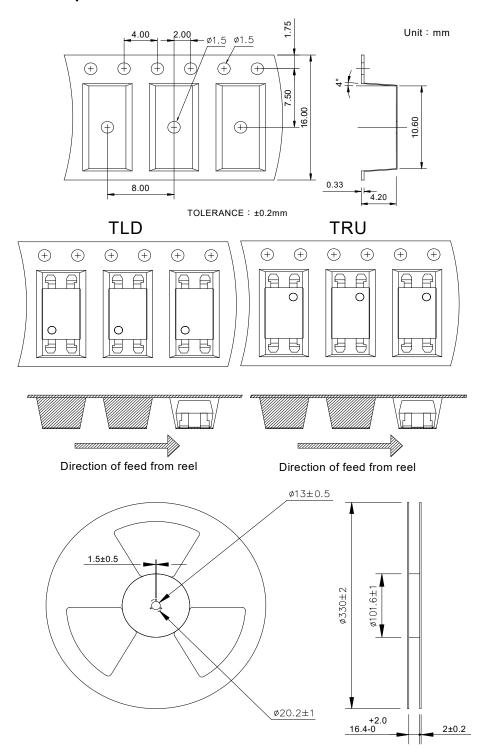
#### 4-pin SOP



Unit: mm

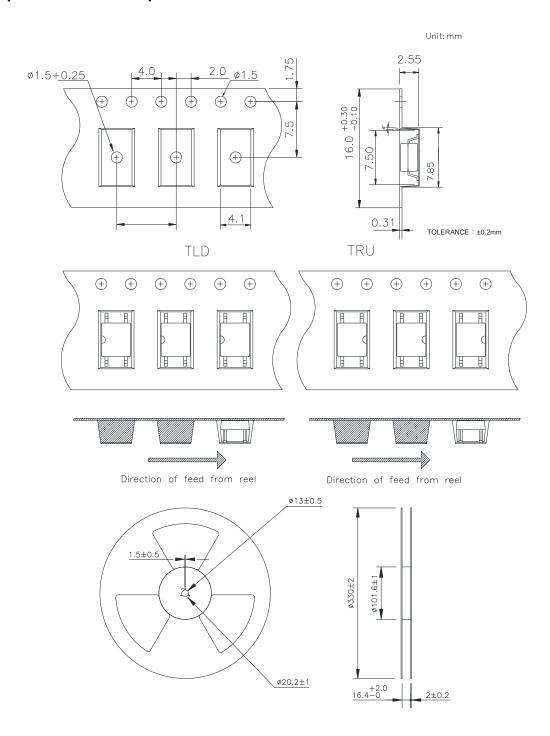


#### • 4-pin SMD Carrier Tape & Reel





#### • 4-pin SOP Carrier Tape & Reel



# KAQY212 Series 4PIN 60V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

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